

Title (en)  
TOUCH DISPLAY DEVICE AND MANUFACTURING METHOD THEREOF

Title (de)  
BERÜHRUNGSANZEIGEVORRICHTUNG UND HERSTELLUNGSVERFAHREN DAFÜR

Title (fr)  
DISPOSITIF D'AFFICHAGE TACTILE ET PROCÉDÉ DE FABRICATION DE CE DERNIER

Publication  
**EP 2769415 A4 20150805 (EN)**

Application  
**EP 11874376 A 20111019**

Priority  
CN 2011080972 W 20111019

Abstract (en)  
[origin: WO2013056433A1] The present invention discloses a touch display device and a manufacturing method thereof, the display device (2) comprising: an OLED display layer (90) disposed on a lower substrate (30); an upper substrate (20); an air layer (603) formed between the upper substrate (20) and the lower substrate (30); and a touch module (60), disposed above the OLED display layer (90), wherein the touch module (60) comprises: a first sensing circuit layer (601) and a second sensing circuit layer (602), further wherein the first sensing circuit layer (601) and the second sensing circuit layer (602) are spaced and the distance between them is more than 2  $\mu\text{m}$ . The display device can reduce interference in detection circuit caused by coupling capacitance formed between the sensing circuit layers thereby improving accuracy of touch detection.

IPC 8 full level  
**H01L 27/32** (2006.01); **G06F 3/044** (2006.01)

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Citation (search report)

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Citation (examination)

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- See also references of WO 2013056433A1

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